

EVLYS LTD. - POWER SEMICONDUCTORS DEVICES -
Wholesale and Retail.

Phase Control Disc Thyristor Type DT80-2500-18

High power cycling capability / Low on-state and switching losses
 Designed for traction and industrial applications

Mean on-state current			I _{TAV}	2500 A				
Repetitive peak off-state voltage			V _{DRM}	1000 ÷ 1800 V				
Repetitive peak reverse voltage			V _{RRM}					
Turn-off time			t _q	250, 320, 400, 500 µs				
V _{DRM} , V _{RRM} , V	1000	1100	1200	1300	1400	1500	1600	1800
Voltage code	10	11	12	13	14	15	16	18
T _j , °C	-60 ÷ 125							

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I _{TAV}	Mean on-state current	A	2500 3158	T _c =95 °C, Double side cooled T _c =85 °C, Double side cooled 180° half-sine wave; 50 Hz	
I _{TRMS}	RMS on-state current	A	3925	T _c =95 °C, Double side cooled 180° half-sine wave; 50 Hz	
I _{TSM}	Surge on-state current	kA	69.0 79.0	T _j =T _j ^{max} T _j =25 °C	180° half-sine wave; t _p =10 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs
			72.0 83.0	T _j =T _j ^{max} T _j =25 °C	180° half-sine wave; t _p =8.3 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs
I ² t	Safety factor	A ² ·10 ³	23800 31200	T _j =T _j ^{max} T _j =25 °C	180° half-sine wave; t _p =10 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs
			21500 28500	T _j =T _j ^{max} T _j =25 °C	180° half-sine wave; t _p =8.3 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs
BLOCKING					
V _{DRM} , V _{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	1000÷1800	T _{j min} < T _j <T _j ^{max} ; 180° half-sine wave; 50 Hz; Gate open	
V _{DSM} , V _{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	1100÷1900	T _{j min} < T _j <T _j ^{max} ; 180° half-sine wave; single pulse; Gate open	
V _D , V _R	Direct off-state and Direct reverse voltages	V	0.6·V _{DRM} 0.6·V _{RRM}	T _j =T _j ^{max} ; Gate open	

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TRIGGERING				
I_{FGM}	Peak forward gate current	A	10	$T_j = T_{j \max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	5	$T_j = T_{j \max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1$ Hz)	A/ μ s	2000	$T_j = T_{j \max}; V_D = 0.67V_{DRM}; I_{TM} = 6400$ A; Gate pulse: $I_G = 2$ A; $t_{GP} = 50$ μ s; $di_G/dt \geq 2$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	°C	-60÷50	
T_j	Operating junction temperature	°C	-60÷125	
MECHANICAL				
F	Mounting force	kN	40.0÷50.0	
a	Acceleration	m/s ²	50	Device clamped

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions
ON-STATE				
V_{TM}	Peak on-state voltage, max	V	1.55	$T_j = 25$ °C; $I_{TM} = 7850$ A
$V_{T(TO)}$	On-state threshold voltage, max	V	0.909	$T_j = T_{j \max};$
r_T	On-state slope resistance, max	$m\Omega$	0.075	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$
I_L	Latching current, max	mA	1500	$T_j = 25$ °C; $V_D = 12$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50$ μ s; $di_G/dt \geq 1$ A/ μ s
I_H	Holding current, max	mA	300	$T_j = 25$ °C; $V_D = 12$ V; Gate open
BLOCKING				
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	300	$T_j = T_{j \max};$ $V_D = V_{DRM}; V_R = V_{RRM}$
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μ s	200, 320, 500, 1000, 1600, 2000, 2500	$T_j = T_{j \max};$ $V_D = 0.67V_{DRM}$; Gate open
TRIGGERING				
V_{GT}	Gate trigger direct voltage, max	V	3.00 2.50 1.50	$T_j = T_{j \min}$ $T_j = 25$ °C $T_j = T_{j \max}$
I_{GT}	Gate trigger direct current, max	mA	400 250 150	$T_j = T_{j \min}$ $T_j = 25$ °C $T_j = T_{j \max}$
V_{GD}	Gate non-trigger direct voltage, min	V	0.35	$T_j = T_{j \max};$
I_{GD}	Gate non-trigger direct current, min	mA	30.00	$V_D = 0.67V_{DRM};$ Direct gate current
SWITCHING				
t_{gd}	Delay time, max	μ s	0.90	$T_j = 25$ °C; $V_D = 1000$ V; $I_{TM} = I_{TAV};$ $di/dt = 200$ A/ μ s;
t_{gt}	Turn-on time	μ s	3.00	Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50$ μ s; $di_G/dt = 2$ A/ μ s
t_q	Turn-off time ²⁾ , max	μ s	250, 320, 400, 500	$dv_D/dt = 50$ V/ μ s; $T_j = T_{j \max}; I_{TM} = I_{TAV};$ $di_R/dt = -10$ A/ μ s; $V_R = 100$ V; $V_D = 0.67V_{DRM}$
Q_{rr}	Total recovered charge, max	μ C	2970	$T_j = T_{j \max}; I_{TM} = 1600$ A;
t_{rr}	Reverse recovery time, max	μ s	29	$di_R/dt = -10$ A/ μ s;
I_{rrM}	Peak reverse recovery current, max	A	205	$V_R = 100$ V

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THERMAL				
R_{thjc}	Thermal resistance, junction to case, max	$^{\circ}\text{C}/\text{W}$	0.0085	Double side cooled Anode side cooled Cathode side cooled
R_{thjc-A}			0.0187	
R_{thjc-K}			0.0153	
R_{thck}	Thermal resistance, case to heatsink, max	$^{\circ}\text{C}/\text{W}$	0.0020	Direct current

MECHANICAL				
w	Weight, max	g	1500	
D_s	Surface creepage distance	mm (inch)	36.60 (1.441)	
D_a	Air strike distance	mm (inch)	16.20 (0.638)	

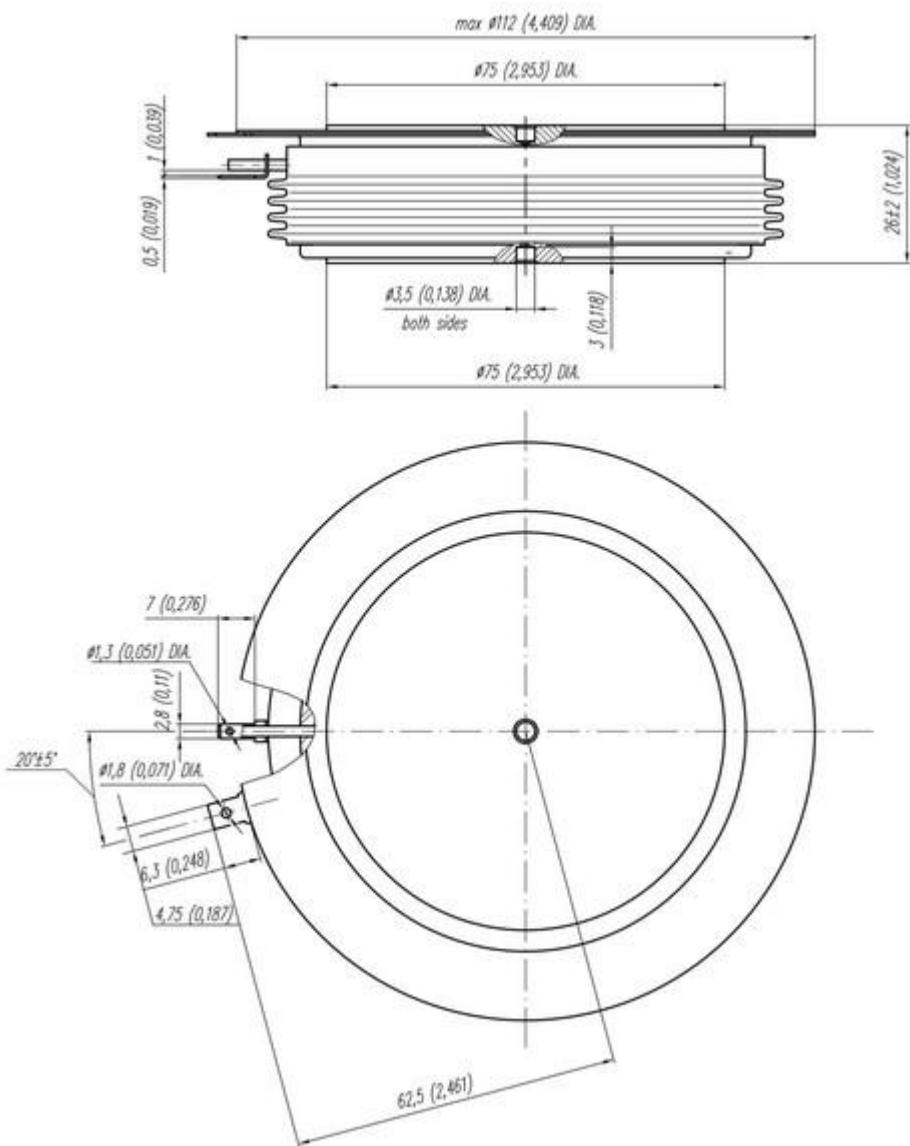
PART NUMBERING GUIDE						NOTES																						
DT	80	2500	18	7	3																							
1	2	3	4	5	6																							
1. DT - Phase Control Disc Thyristor						1) Critical rate of rise of off-state voltage																						
2. Element Diameter						<table border="1" style="width: 100%;"> <tr> <td>Symbol of Group</td> <td>4</td> <td>5</td> <td>6</td> <td>7</td> <td>8</td> <td>8.5</td> <td>9</td> </tr> <tr> <td>$(dv_0/dt)_{crit}, \text{V}/\mu\text{s}$</td> <td>200</td> <td>320</td> <td>500</td> <td>1000</td> <td>1600</td> <td>2000</td> <td>2500</td> </tr> </table>							Symbol of Group	4	5	6	7	8	8.5	9	$(dv_0/dt)_{crit}, \text{V}/\mu\text{s}$	200	320	500	1000	1600	2000	2500
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3. Mean on-state current, A						2) Turn-off time ($dv_D/dt=50 \text{ V}/\mu\text{s}$)																						
4. Voltage code						<table border="1" style="width: 100%;"> <tr> <td>Symbol of Group</td> <td>0</td> <td>0</td> <td>0</td> <td>0</td> </tr> <tr> <td>$t_{q, \mu\text{s}}$</td> <td>250</td> <td>320</td> <td>400</td> <td>500</td> </tr> </table>							Symbol of Group	0	0	0	0	$t_{q, \mu\text{s}}$	250	320	400	500						
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OVERALL DIMENSIONS

Package type: T.F2



All dimensions in millimeters (inches)